

DOCKET NO. 01-C-084 (STMI01-01084)
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : Harry Michael Siegel, et al.
Serial No. : 10/066,245
Filed : January 31, 2002
For : METHOD FOR USING A PRE-FORMED FILM IN A TRANSFER
MOLDING PROCESS FOR AN INTEGRATED CIRCUIT (AS
AMENDED)
Group No. : 1791
Examiner : Edmund H. Lee
Confirmation No. : 2782

MAIL STOP AF

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

SECOND SUBSTITUTE AMENDMENT AND RESPONSE TO FINAL OFFICE ACTION

Applicant respectfully withdraws the Amendment and Response to Final Office Action filed March 17, 2008 and the Substitute Amendment and Response to Final Office Action filed July 3, 2008, and requests amendment the above-identified application as follows: